

4

3

2

1

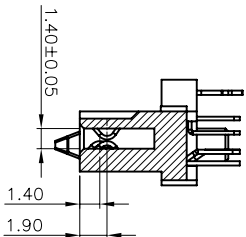
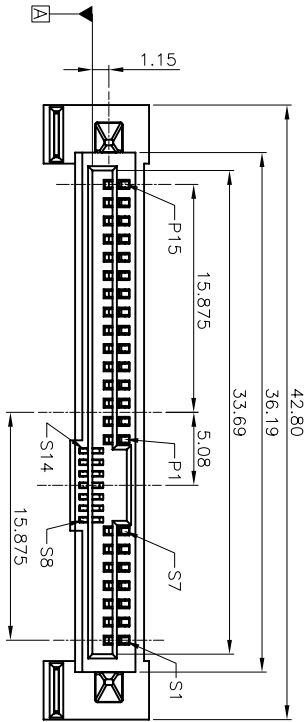
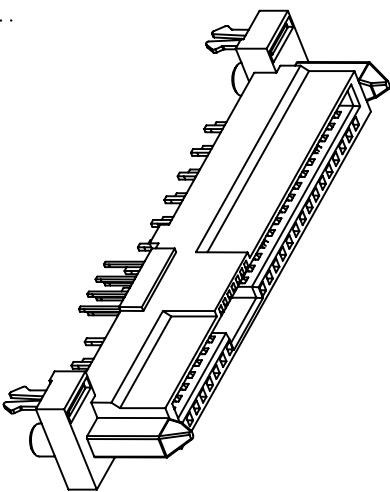
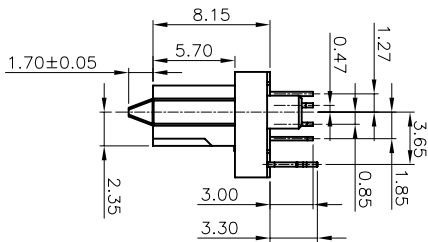
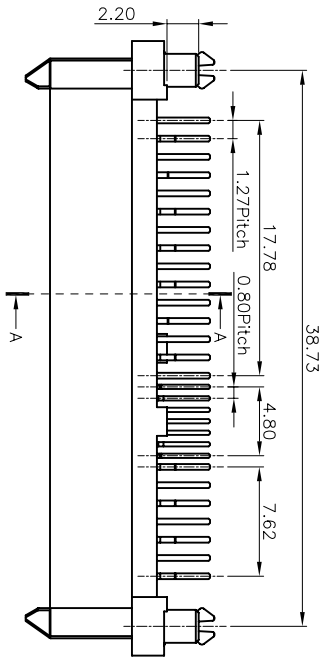
PART NO. SEE TABLE 1

CUSTOMER
DRAWING

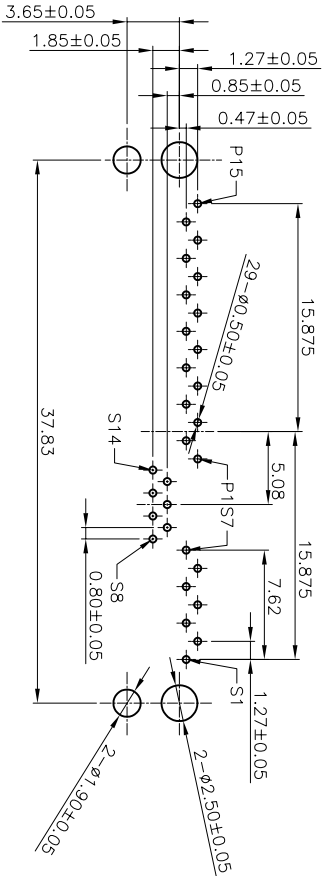
REVISIONS			
LTR	DESCRIPTION	Drawing	DATE
B	Initial Release for Manufacture	MarCy	03/08/06

TABLE 1

020-01-00177	15 U" GOLD	NY9T BLACK
020-01-00176	GOLD FLASH	NY9T BLACK
PART NO.	PLATED	COLOR FOR THE PLASTIC



RECOMMENDED PCB LAYOUT



NOTE:

- 1.MATERIAL :
HOUSING : High Temperature thermoplastic ,
UL94V-0, COLOR : BLACK
TERMINAL(max):Copper alloy,THICKNESS = 0.30 mm
TERMINAL(min):Copper alloy,THICKNESS = 0.25 mm
FORKLOCK: Copper alloy,THICKNESS = 0.30 mm
- 2.PLATING:
CONTACT:GOLD OVER 50u" MIN NICKEL UNDERPLATE(SEE TABLE1)
SOLDER TAIL:75u"MIN TIN 50u" MIN NICKEL UNDERPLATE
GOLD SPECIFICATION:
a, Flash: b, 15u"; c, 30u";
3.ELECTRONICAL SPECIFICATION:
CURRENT RATING:1.5 AMPERE PER CONTACT
CONTACT RESISTANCE:30 MILLIOHMS MAX.
INSULATION RESISTANCE:1000 MEGOHMS MIN.
DIELECTRIC WITHSTANDING VOLTAGE:500 VAC.
OPERATING TEMPERATURE:-55C° ~+125C°

DESCRIPTION

DIMENSION ARE MILLIMETERS TOLERANCES ARE : DECIMALS X. ± 0.30 .XX ± 0.25 ANGLE: X ± 3°	APPROVALS		DATE	E-GREEN TITLE: ASSEMBLY OF SAS 29P Vertical DIP(4 ROW)			
	DRAWN	Marcy	03/08/06				
	CHECKED						
	APPROVALS						
	DO NOT SCALE DRAWING						
SIZE		SCALE :		DRAWING NO.		REV.	
mm		1 : 1				B	
D NO.		XXXXXXXXXX				SHEET 1 OF 1	

A

B

C

D

A

B

C

D